

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Stephen W. Bedell Examiner: Heather A. Doty

Serial No.: 10/710,826 Group Art Unit: 2813

Filed: August 5, 2004 Attorney Docket No: FIS920040069

Title: METHOD OF FORMING STRAINED SILICON MATERIALS WITH
IMPROVED THERMAL CONDUCTIVITY

AMENDMENT AND RESPONSE

Mail Stop Non-Fee Amendment
Assistant Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This paper is submitted in response to an Office Action mailed April 11, 2006 by the United States Patent and Trademark Office in connection with the above-identified Application. A response to this April 11, 2006 Office Action is due by July 11, 2006. Therefore, this response is being timely filed.

Amendments to the claims begin on page 2 of this paper.

Remarks begin on page 5 of this paper.